MII75-12A3

## IGBT (NPT) Module

| $\mathrm{V}_{\text {CES }}=2 \times 1200 \mathrm{~V}$ |  |
| :--- | ---: |
| $\mathrm{I}_{\text {C25 }}=$ | 90 A |
| $\mathrm{~V}_{\text {CE(sat) }}=$ | 2.2 V |

## Phase leg

## Part number

MII75-12A3


Backside: isolated
TE72873

## Features / Advantages:

- NPT IGBT technology
- low saturation voltage
- low switching losses
- switching frequency up to 30 kHz
- square RBSOA, no latch up
- high short circuit capability
- positive temperature coefficient for easy parallelling
- MOS input, voltage controlled
- ultra fast free wheeling diodes


## Applications:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans


## Package: Y4

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

| IGBT |  |  |  | Ratings |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Symbol | Definition | Conditions |  | min. | typ. | max. | Unit |
| $\mathrm{V}_{\text {cES }}$ | collector emitter voltage |  | $\mathrm{T}_{\mathrm{v},}=25^{\circ} \mathrm{C}$ |  |  | 1200 | V |
| $\mathrm{V}_{\text {GES }}$ | max. DC gate voltage |  |  |  |  | $\pm 20$ | V |
| $\mathrm{V}_{\text {GEM }}$ | max. transient gate emitter voltage |  |  |  |  | $\pm 30$ | V |
| $\mathrm{I}_{\mathrm{C} 25}$ | collector current |  | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ |  |  | 90 | A |
| $\mathrm{I}_{\mathrm{C} 80}$ |  |  | $\mathrm{T}_{\mathrm{C}}=80^{\circ} \mathrm{C}$ |  |  | 60 | A |
| $\mathrm{P}_{\text {tot }}$ | total power dissipation |  | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ |  |  | 370 | W |
| $\mathrm{V}_{\text {CE(sat) }}$ | collector emitter saturation voltage | $\mathrm{I}_{\mathrm{C}}=50 \mathrm{~A} ; \mathrm{V}_{\mathrm{GE}}=15 \mathrm{~V}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{v} s}=25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{v} s}=125^{\circ} \mathrm{C} \end{aligned}$ |  | $\begin{aligned} & 2.2 \\ & 2.7 \end{aligned}$ | 2.7 | V V |
| $\mathrm{V}_{\text {GE(th) }}$ | gate emitter threshold voltage | $\mathrm{I}_{\mathrm{C}}=2 \mathrm{~mA} ; \mathrm{V}_{\text {GE }}=\mathrm{V}_{\text {CE }}$ | $\mathrm{T}_{\mathrm{v},}=25^{\circ} \mathrm{C}$ | 4.5 | 5.5 | 6.5 | V |
| $\mathrm{I}_{\text {CES }}$ | collector emitter leakage current | $\mathrm{V}_{\text {CE }}=\mathrm{V}_{\text {CES }} ; \mathrm{V}_{\text {GE }}=0 \mathrm{~V}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{v} s}=25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{v} s}=125^{\circ} \mathrm{C} \end{aligned}$ |  | 6 | 4 | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| $\mathrm{I}_{\text {GES }}$ | gate emitter leakage current | $\mathrm{V}_{\mathrm{GE}}= \pm 20 \mathrm{~V}$ |  |  |  | 200 | nA |
| $\mathrm{Q}_{\text {G(on) }}$ | total gate charge | $\mathrm{V}_{\text {CE }}=600 \mathrm{~V} ; \mathrm{V}_{\mathrm{GE}}=15 \mathrm{~V} ; \mathrm{I}_{\mathrm{C}}=$ | 50 A |  | 240 |  | nC |
| $\begin{aligned} & \hline t_{\mathrm{d}(\text { (n) }} \\ & t_{\mathrm{r}} \\ & \mathrm{t}_{\mathrm{d}(\mathrm{ff})} \\ & \mathrm{t}_{\mathrm{f}} \\ & \mathrm{E}_{\mathrm{on}} \\ & \mathrm{E}_{\mathrm{off}} \end{aligned}$ | turn-on delay time current rise time turn-off delay time current fall time turn-on energy per pulse turn-off energy per pulse | inductive load $\begin{aligned} & V_{C E}=600 \mathrm{~V} ; I_{C}=50 \mathrm{~A} \\ & V_{G E}= \pm 15 \mathrm{~V} ; \mathrm{R}_{\mathrm{G}}=22 \Omega \end{aligned}$ | $\mathrm{T}_{\mathrm{v},}=125^{\circ} \mathrm{C}$ |  | $\begin{array}{r} 100 \\ 70 \\ 500 \\ 70 \\ 7.6 \\ 5.6 \end{array}$ |  | ns ns ns ns mJ mJ |
| $\begin{aligned} & \text { RBSOA } \\ & I_{C M} \end{aligned}$ | reverse bias safe operating area | $\left\{\begin{array}{l} \mathrm{V}_{\mathrm{GE}}= \pm 15 \mathrm{~V} ; \mathrm{R}_{\mathrm{G}}=22 \Omega \\ \mathrm{~V}_{\mathrm{CE} \max }=1200 \mathrm{~V} \end{array}\right.$ | $\mathrm{T}_{\mathrm{v},}=125^{\circ} \mathrm{C}$ |  |  | 100 | A |
| $\begin{aligned} & \overline{\mathrm{SCSOA}} \\ & \mathrm{t}_{\mathrm{sc}} \\ & \mathrm{I}_{\mathrm{sc}} \end{aligned}$ | short circuit safe operating area short circuit duration short circuit current | $\left\{\begin{array}{l} \mathrm{V}_{\mathrm{CEmax}}=1200 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{CE}}=1200 \mathrm{~V} ; \mathrm{V}_{\mathrm{GE}}= \pm 15 \mathrm{~V} \\ \mathrm{R}_{\mathrm{G}}=22 \Omega ; \text { non-repetitive } \end{array}\right.$ | $\mathrm{T}_{\mathrm{v},}=125^{\circ} \mathrm{C}$ |  | 180 | 10 | $\mu \mathrm{S}$ A |
| $\mathrm{R}_{\text {thJc }}$ | thermal resistance junction to case |  |  |  |  | 0.33 | K/W |
| $\mathrm{R}_{\text {thCH }}$ | thermal resistance case to heatsink |  |  |  | 0.33 |  | K/W |
| Diode |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {RRM }}$ | max. repetitive reverse voltage |  | $\mathrm{T}_{\mathrm{v},}=25^{\circ} \mathrm{C}$ |  |  | 1200 | V |
| IF 25 | forward current |  | $\mathrm{T}_{\mathrm{c}}=25^{\circ} \mathrm{C}$ |  |  | 100 | A |
| $\mathrm{I}_{\text {F80 }}$ |  |  | $\mathrm{T}_{\mathrm{C}}=80^{\circ} \mathrm{C}$ |  |  | 60 | A |
| $\bar{V}_{\text {F }}$ | forward voltage | $\mathrm{I}_{\mathrm{F}}=50 \mathrm{~A}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{v}\lrcorner}=25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{v} s}=125^{\circ} \mathrm{C} \end{aligned}$ |  | 1.80 | 2.50 | V |
| $\mathrm{I}_{\mathrm{R}}$ | reverse current | $\mathrm{V}_{\mathrm{R}}=\mathrm{V}_{\text {RRM }}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{v} v}=25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{v} v}=125^{\circ} \mathrm{C} \end{aligned}$ |  | 1 | 0.65 | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| $\begin{aligned} & \hline \mathrm{Q}_{\mathrm{r}} \\ & \mathrm{I}_{\mathrm{RM}} \\ & \mathrm{t}_{\mathrm{r}} \\ & \mathrm{E}_{\mathrm{rec}} \end{aligned}$ | reverse recovery charge max. reverse recovery current reverse recovery time reverse recovery energy | $\left\{\begin{array}{l} V_{R}=600 \mathrm{~V} \\ -d i_{F} / \mathrm{dt}=400 \mathrm{~A} / \mu \mathrm{s} \\ \mathrm{I}_{\mathrm{F}}=50 \mathrm{~A} ; \mathrm{V}_{\mathrm{GE}}=0 \mathrm{~V} \end{array}\right.$ | $\mathrm{T}_{\mathrm{v},}=125^{\circ} \mathrm{C}$ |  | 3.5 40 200 1 |  | $\mu \mathrm{C}$ A ns mJ |
| $\mathrm{R}_{\text {thJ }}$ | thermal resistance junction to case |  |  |  |  | 0.66 | K/W |
| $\mathrm{R}_{\text {thCH }}$ | thermal resistance case to heatsink |  |  |  | 0.66 |  | K/W |




| Ordering | Part Number | Marking on Product | Delivery Mode | Quantity | Code No. |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Standard | MII75-12A3 | MII75-12A3 | Box | 6 | 466735 |


| Equivalent Circuits for Simulation | *on die level | $\mathrm{T}_{\mathrm{v} \delta}=150^{\circ} \mathrm{C}$ |
| :---: | :---: | :---: |
| $\mathrm{I} \rightarrow \mathrm{~V}_{0}-\mathrm{R}_{0}$ | IGBT | Diode |
| $\mathrm{V}_{0 \text { max }}$ threshold voltage | 1.5 | 1.3 V |
| $\mathbf{R}_{0 \text { max }}$ slope resistance * | 20.1 | $10.8 \mathrm{~m} \Omega$ |

Outlines Y4


## IGBT



Fig. 1 Typ. output characteristics


Fig. 4 Typ. turn-on gate charge


Fig. 12 Typical transient thermal impedance


Fig. 2 Typ. output characteristics


Fig. 5 Typ. turn on energy \& switching times versus collector current


Fig. 9 Typ. turn on energy \& switching times versus gate resistor


Fig. 3 Typ. transfer characteristics


Fig. 6 Typ. turn off energy \& switching times versus collector current


Fig. 9 Typ. turn off energy \& switching times versus gate resistor

MII75-12A3


Fig. 1 Typ. Forward current vs. $\mathrm{V}_{\mathrm{F}}$


Fig. 2 Typ. transient thermal impedance junction to case

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